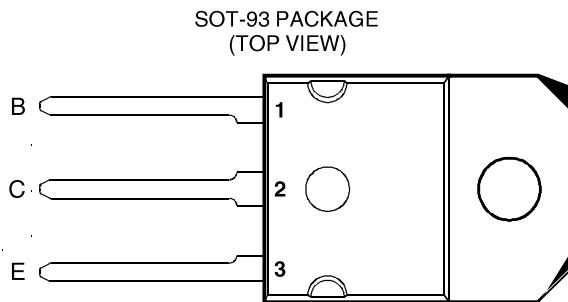




BUV48, BUV48A NPN SILICON POWER TRANSISTORS

- Rugged Triple-Diffused Planar Construction
- 15 A Continuous Collector Current
- 1000 Volt Blocking Capability



Pin 2 is in electrical contact with the mounting base.

absolute maximum ratings **at 25°C case temperature (unless otherwise noted)**

RATING	SYMBOL	VALUE	UNIT
Collector-emitter voltage ($V_{BE} = 0$ V)	V_{CES} BUV48 BUV48A	850 1000	V
Collector-emitter voltage ($R_{BE} = 10 \Omega$)	V_{CER} BUV48 BUV48A	850 1000	V
Collector-emitter voltage ($I_B = 0$)	V_{CEO} BUV48 BUV48A	400 450	V
Continuous collector current	I_C	15	A
Peak collector current (see Note 1)	I_{CM}	30	A
Continuous base current	I_B	4	A
Peak base current	I_{BM}	20	A
Non repetitive accidental peak surge current	I_{CSM}	55	A
Continuous device dissipation at (or below) 25°C case temperature	P_{tot}	125	W
Operating junction temperature range	T_j	-65 to +150	°C
Storage temperature range	T_{stg}	-65 to +150	°C

NOTE 1: This value applies for $t_p \leq 2$ ms, duty cycle $\leq 2\%$.

BUV48, BUV48A NPN SILICON POWER TRANSISTORS

electrical characteristics at 25°C case temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS				MIN	TYP	MAX	UNIT	
$V_{CEO(sus)}$	Collector-emitter sustaining voltage	$I_C = 200 \text{ mA}$	$L = 25 \text{ mH}$	(see Note 2)	BUV48 BUV48A	400 450			V
I_{CES}	Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$	$V_{BE} = 0$		BUV48		0.2		
		$V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$		BUV48A		0.2		
		$V_{CE} = 850 \text{ V}$	$V_{BE} = 0$	$T_C = 125^\circ\text{C}$	BUV48		2.0		mA
		$V_{CE} = 1000 \text{ V}$	$V_{BE} = 0$	$T_C = 125^\circ\text{C}$	BUV48A		2.0		
I_{CER}	Collector-emitter cut-off current	$V_{CE} = 850 \text{ V}$	$R_{BE} = 10 \Omega$		BUV48		0.5		
		$V_{CE} = 1000 \text{ V}$	$R_{BE} = 10 \Omega$		BUV48A		0.5		
		$V_{CE} = 850 \text{ V}$	$R_{BE} = 10 \Omega$	$T_C = 125^\circ\text{C}$	BUV48		4.0		mA
		$V_{CE} = 1000 \text{ V}$	$R_{BE} = 10 \Omega$	$T_C = 125^\circ\text{C}$	BUV48A		4.0		
I_{EBO}	Emitter cut-off current	$V_{EB} = 5 \text{ V}$	$I_C = 0$				1		mA
V_{EBO}	Emitter-base breakdown voltage	$I_E = 50 \text{ mA}$	$I_C = 0$			7		30	V
$V_{CE(sat)}$	Collector-emitter saturation voltage	$I_B = 2 \text{ A}$	$I_C = 10 \text{ A}$		BUV48		1.5		
		$I_B = 3 \text{ A}$	$I_C = 15 \text{ A}$		BUV48		5.0		
		$I_B = 1.6 \text{ A}$	$I_C = 8 \text{ A}$	(see Notes 3 and 4)	BUV48A		1.5		V
		$I_B = 2.4 \text{ A}$	$I_C = 12 \text{ A}$		BUV48A		5.0		
$V_{BE(sat)}$	Base-emitter saturation voltage	$I_B = 2 \text{ A}$	$I_C = 10 \text{ A}$	(see Notes 3 and 4)	BUV48		1.6		
		$I_B = 1.6 \text{ A}$	$I_C = 8 \text{ A}$		BUV48A		1.6		V
f_t	Current gain bandwidth product	$V_{CE} = 10 \text{ V}$	$I_C = 0.5 \text{ A}$	$f = 1 \text{ MHz}$			10		MHz
C_{ob}	Output capacitance	$V_{CB} = 20 \text{ V}$	$I_C = 0$	$f = 1 \text{ MHz}$			150		pF

NOTES: 2. Inductive loop switching measurement.

3. These parameters must be measured using pulse techniques, $t_p = 300 \mu\text{s}$, duty cycle $\leq 2\%$.

4. These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

thermal characteristics

PARAMETER	MIN	TYP	MAX	UNIT
$R_{θJC}$ Junction to case thermal resistance			1	°C/W

resistive-load-switching characteristics at 25°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{on}	Turn on time	$I_C = 10 \text{ A}$	$V_{CC} = 150 \text{ V}$	BUV48		1.0	μs
t_s	Storage time	$I_{B(on)} = 2 \text{ A}$	$I_{B(off)} = -2 \text{ A}$	(see Figures 1 and 2)		3.0	μs
t_f	Fall time					0.8	μs
t_{on}	Turn on time	$I_C = 8 \text{ A}$	$V_{CC} = 150 \text{ V}$	BUV48A		1.0	μs
t_s	Storage time	$I_{B(on)} = 1.6 \text{ A}$	$I_{B(off)} = -1.6 \text{ A}$	(see Figures 1 and 2)		3.0	μs
t_f	Fall time					0.8	μs

† Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

inductive-load-switching characteristics at 100°C case temperature

PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t_{sv}	Voltage storage time	$I_C = 10 \text{ A}$	$I_{B(on)} = 2 \text{ A}$	BUV48		4.0	μs
t_{fi}	Current fall time	$V_{BE(off)} = -5 \text{ V}$	(see Figures 3 and 4)			0.4	μs
t_{sv}	Voltage storage time	$I_C = 8 \text{ A}$	$I_{B(on)} = 1.6 \text{ A}$	BUV48A		4.0	μs
t_{fi}	Current fall time	$V_{BE(off)} = -5 \text{ V}$	(see Figures 3 and 4)			0.4	μs

PARAMETER MEASUREMENT INFORMATION

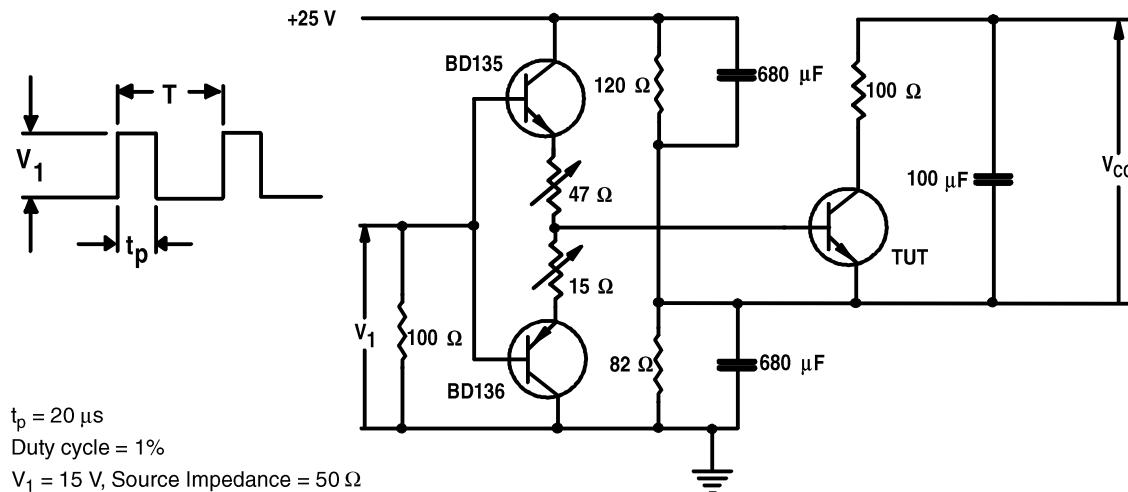


Figure 1. Resistive-Load Switching Test Circuit

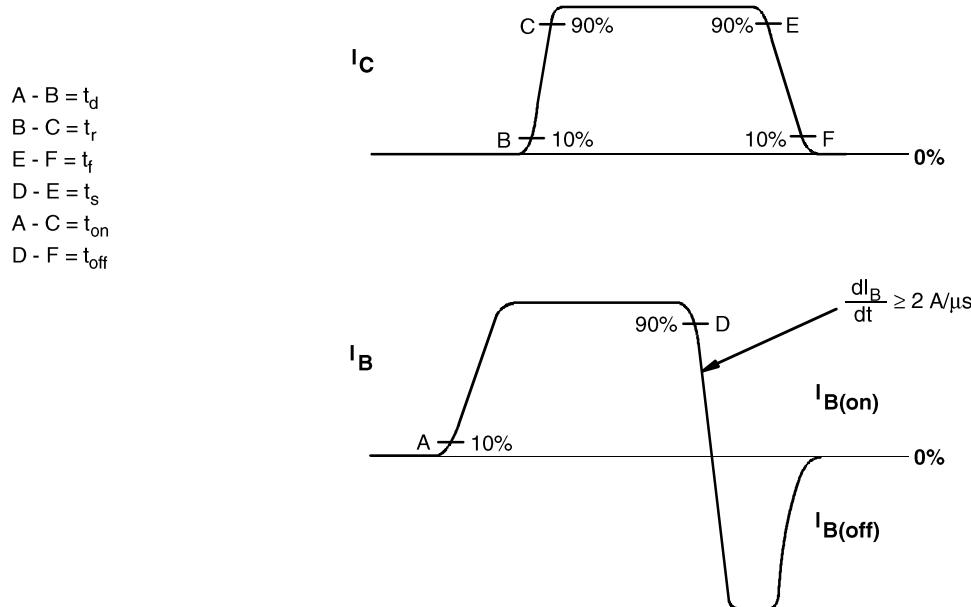


Figure 2. Resistive-Load Switching Waveform

BUV48, BUV48A NPN SILICON POWER TRANSISTORS

PARAMETER MEASUREMENT INFORMATION

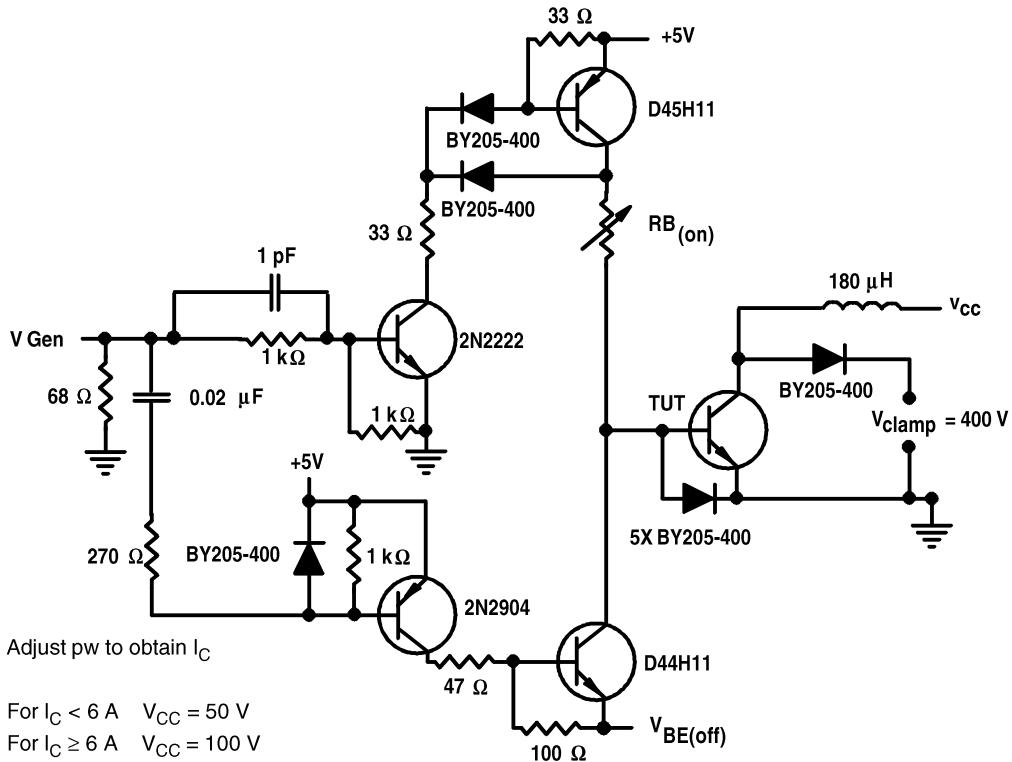
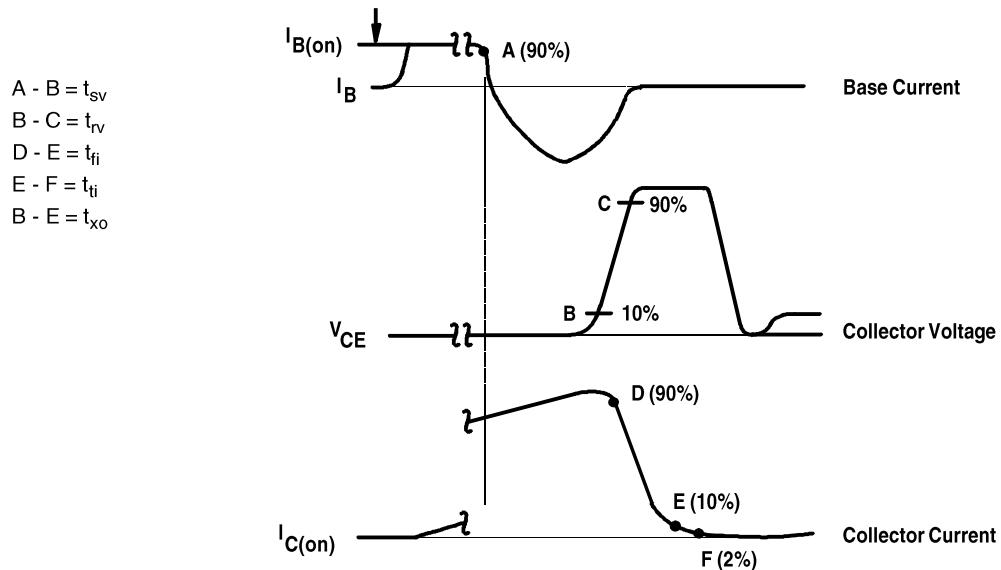


Figure 3. Inductive-Load Switching Test Circuit



NOTES: A. Waveforms are monitored on an oscilloscope with the following characteristics: $t_r < 15 \text{ ns}$, $R_{in} > 10 \Omega$, $C_{in} < 11.5 \text{ pF}$.
 B. Resistors must be noninductive types.

Figure 4. Inductive-Load Switching Waveform

TYPICAL CHARACTERISTICS

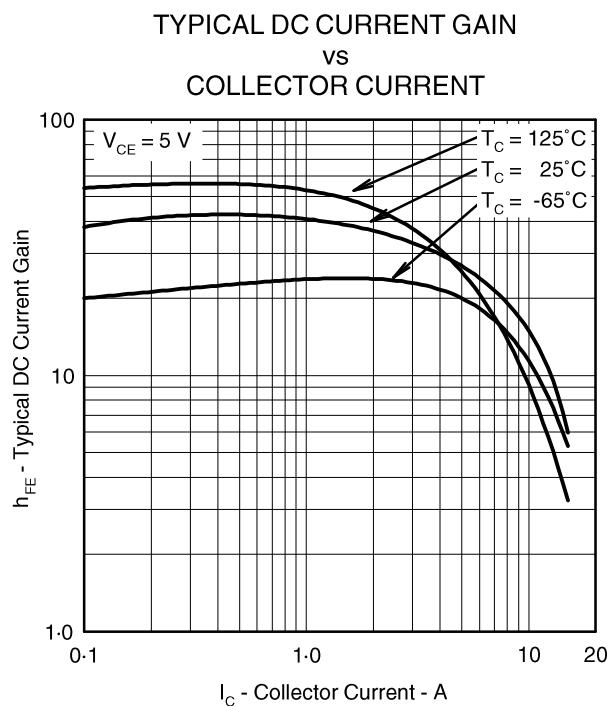


Figure 5.

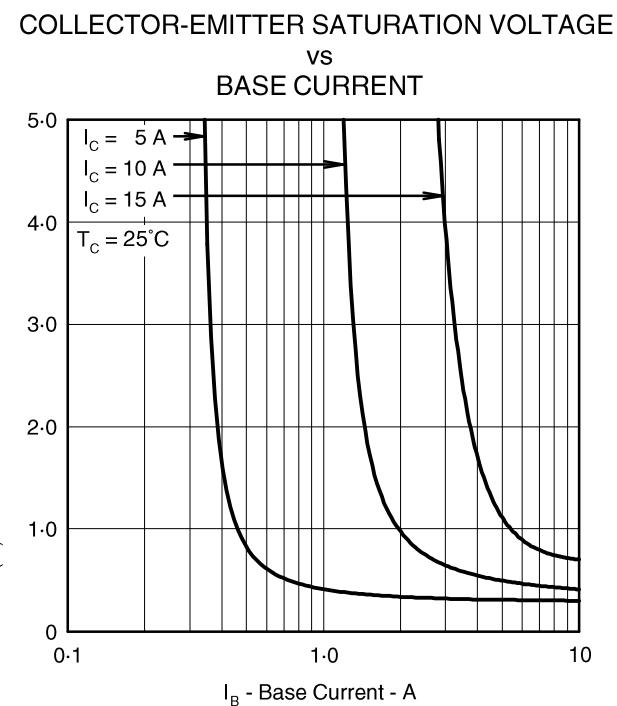


Figure 6.

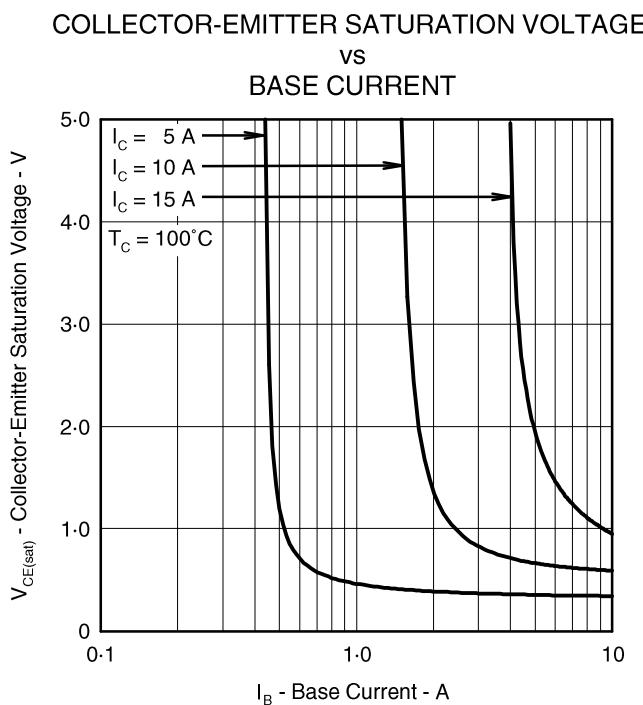


Figure 7.

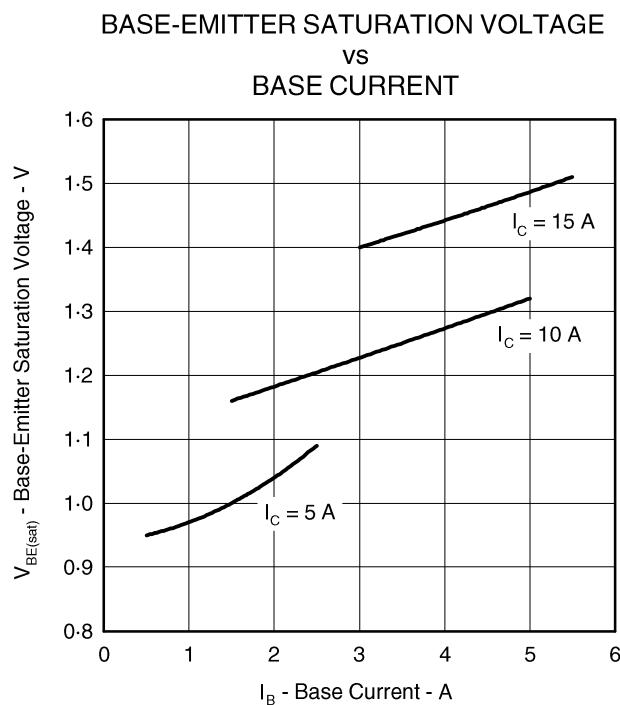


Figure 8.

BUV48, BUV48A NPN SILICON POWER TRANSISTORS

TYPICAL CHARACTERISTICS

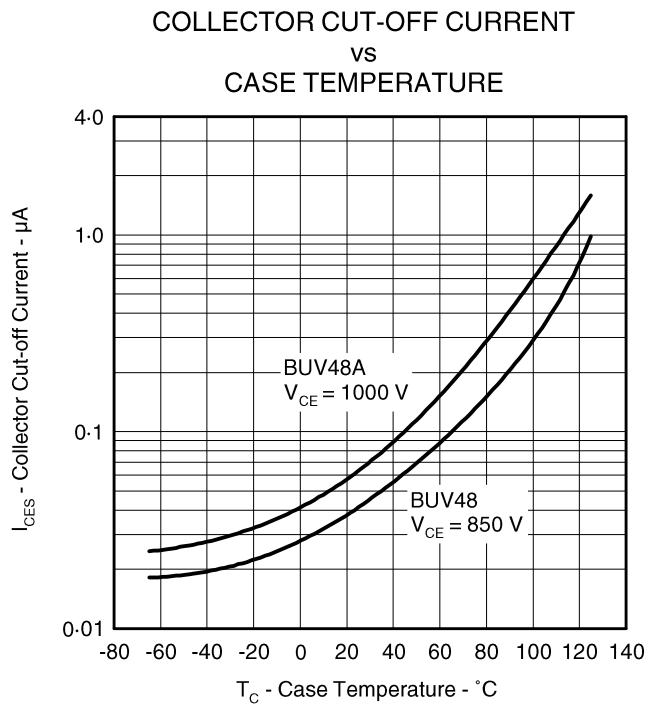


Figure 9.

MAXIMUM SAFE OPERATING REGIONS

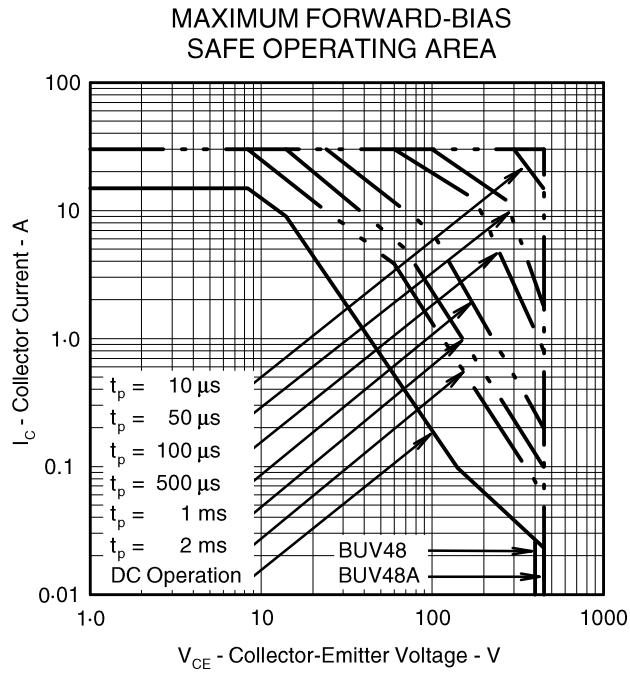


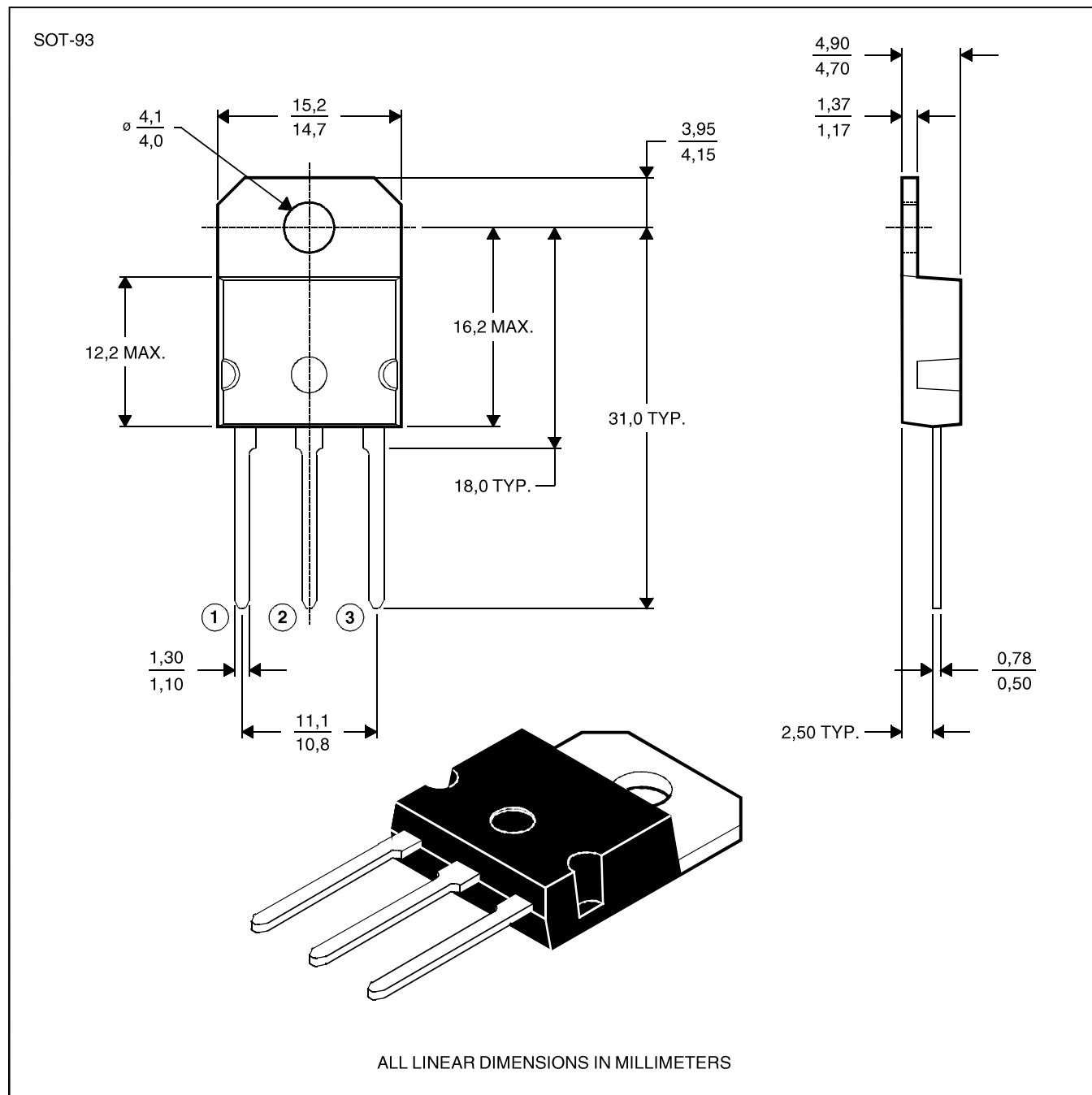
Figure 10.

MECHANICAL DATA

SOT-93

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTE A: The centre pin is in electrical contact with the mounting tab.